

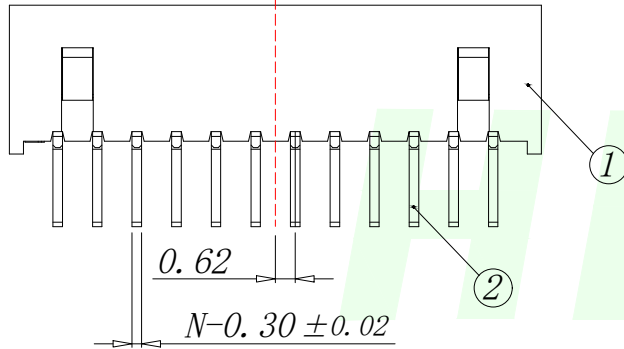
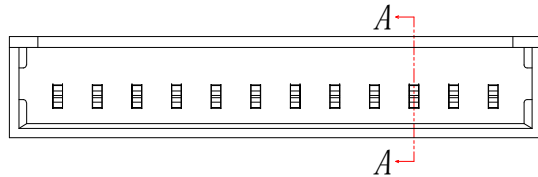
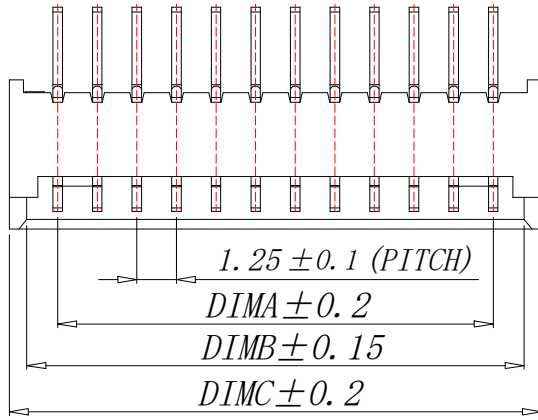
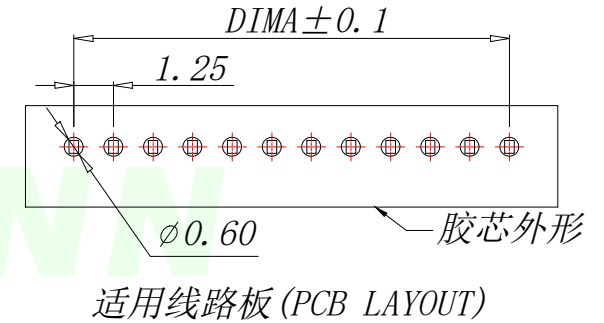
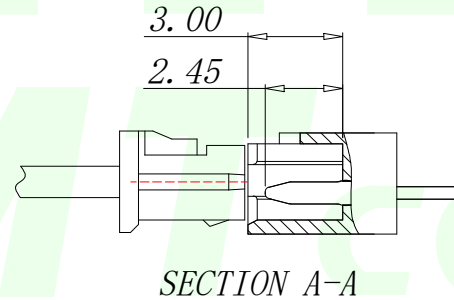
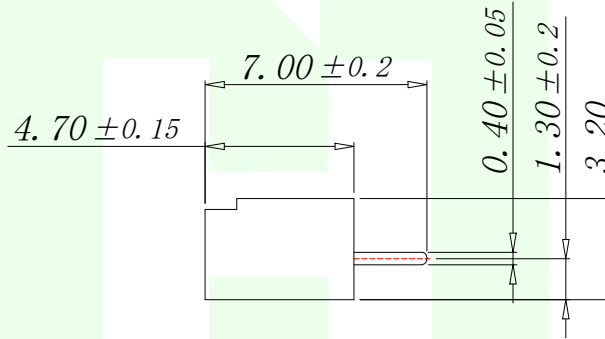
RoHs

Technical Index:

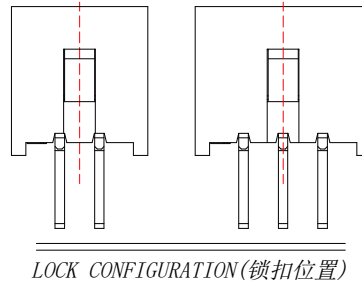
1. The surface of the plastic parts should be smooth, no rough edges, no obvious shrinkage, defects, cracks and other phenomena)
2. Lock Configuration: 2 to 3Pin is 1, $\geq$ 4Pin is 2
3. Temperature range: $-25^{\circ}\text{C}\sim+85^{\circ}\text{C}$.
4. Rated voltage: 125V, AC/DC.
5. Contact resistance: $\leq 0.02\Omega$.
6. Insulation resistance: $\geq 100M\Omega$

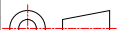
VER	MARK	PR. BY	DESCRIPTION	DATE

Part No	Pin	A	B	C
HMT-MX1.25-ZZH2P	2	1.25	3.20	4.30
HMT-MX1.25-ZZH3P	3	2.50	4.45	5.55
HMT-MX1.25-ZZH4P	4	3.75	5.70	6.80
HMT-MX1.25-ZZH5P	5	5.00	6.95	8.05
HMT-MX1.25-ZZH6P	6	6.25	8.20	9.30
HMT-MX1.25-ZZH7P	7	7.50	9.45	10.55
HMT-MX1.25-ZZH8P	8	8.75	10.70	11.80
HMT-MX1.25-ZZH9P	9	10.00	11.95	13.05
HMT-MX1.25-ZZH10P	10	11.25	13.20	14.30
HMT-MX1.25-ZZH11P	11	12.50	14.45	15.55
HMT-MX1.25-ZZH12P	12	13.75	15.70	16.80
HMT-MX1.25-ZZH13P	13	15.00	16.95	18.05
HMT-MX1.25-ZZH14P	14	16.25	18.20	19.30
HMT-MX1.25-ZZH15P	15	17.50	19.45	20.55
HMT-MX1.25-ZZH16P	16	18.75	20.70	21.80
HMT-MX1.25-ZZH17P	17	20.00	21.95	23.05
HMT-MX1.25-ZZH18P	18	21.25	23.20	24.30
HMT-MX1.25-ZZH19P	19	22.50	24.45	25.55
HMT-MX1.25-ZZH20P	20	23.75	25.70	26.80



序号	品名	材质
1	1.25 Pitch S/T Wire To Board Housing DIP(H=4.7)	PA66 UL94V-2 Yellow
2	1.25 Pitch S/T Wire To Board Terminal DIP(H=4.7)	Copper Alloy/ Tin Plating



GENERAL TOLERANCES UNLESS SPECIFIED		 HMT CONN 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd			
X.° ±0.50	X.° ±5°	PART NO.		TITLE:	
X.X° ±0.20	X.X° ±3°	HMT-MX1.25-ZZHN		1.25 PITCH H4.7 S/T WIRE TO BOARD DIP CONN.	
X.XX° ±0.10	X.XX° ±1°	DESIGN: James	CUSTOMER	SIZE	UNITS
MANUFACTURE DWG		CHED: Talen		A4	MM
		APPD: Sophia		SCALE	SHEET
				N:A	1/1